TECHNICAL SPEC FOR Vertical furnace

System Model:

Specific model:	TEL ALPHA-8SE-D	
Process (Poly, TEOS, Nitride, Pyro, etc.): POCL DOPE		
APCVD or LPCVD:	APCVD	
HDD and SW included or not:	SW installed, tool version with HDD	
Main controller type:	WAVES	
SiC/quartz included or not:	Separated	
Substrate size:	Configured for 6 inch, 8 inch compatible	
SMIF:	No	
Gas config:	For POCL dope process	
Leak detection:	No	
Wafer notch aligner:	6" Jeida flat	
Handler type:	TBAWL	
Indexer:	With wafer counter for 6"	
Carrier type, FOUP:	No FOUP	
Buffer Capacity:	2X6 prod carriers, and 9 carriers for mon, extraDummies, dummies	
Boat type:	170 slots, 150 prod wafers	
Boat rotation:	Yes	
Heater type:	5Zone	
Carrier ID reader:	No	

TEL Alpha 8 series

MFC:	2X N2 and MDOT, 1X O2
Pressure transducer:	N/A

Soft Backfill injector: N/A

CKD-VEC Vacuum pressure controller: N/A

CDA: Yes

Temperature controller: 560A

Exhaust controller: Yes

Power Box: No

Missing parts: No

Defected parts: No

Operating system: WAVES

Serial plate M7X5149

